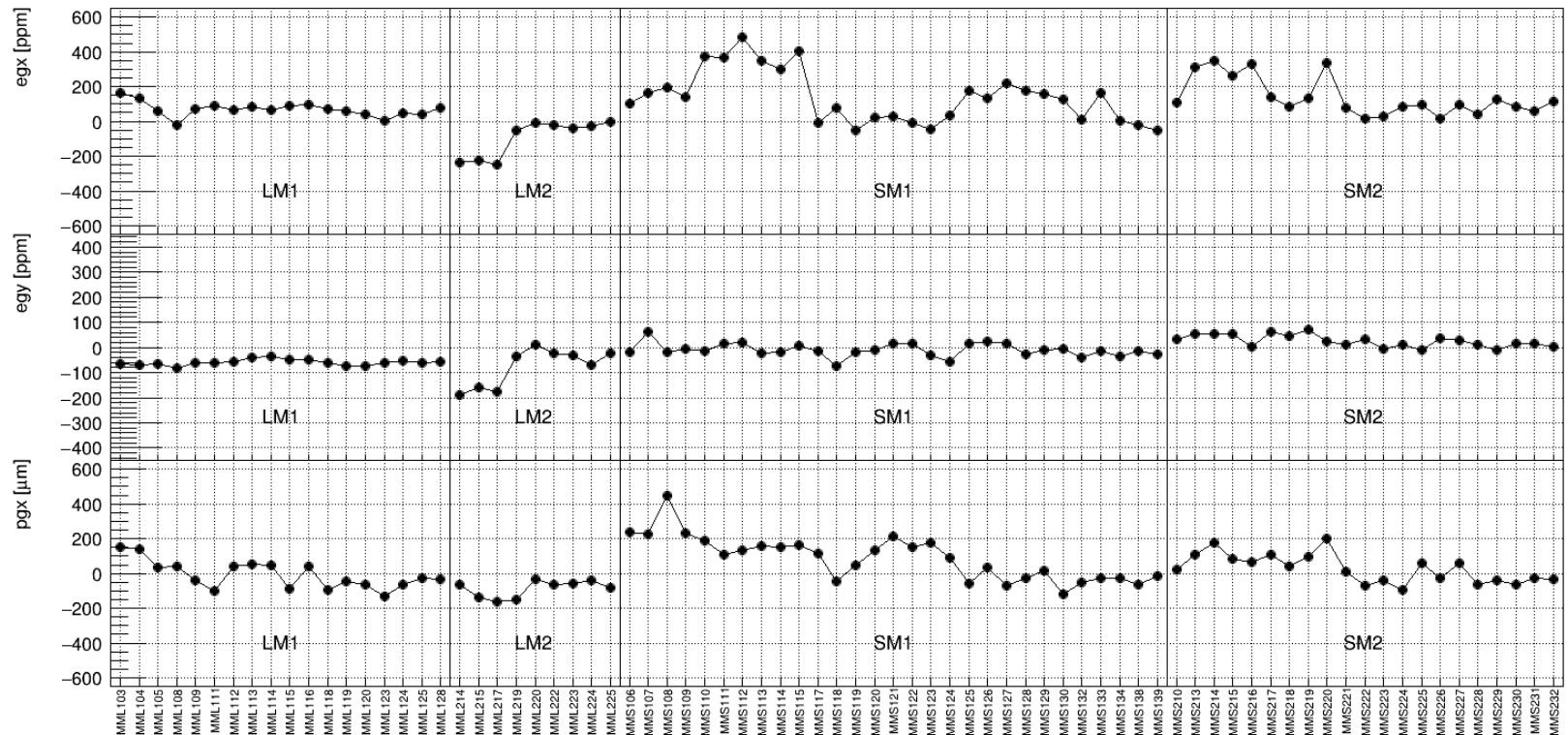


# Investigating pgx



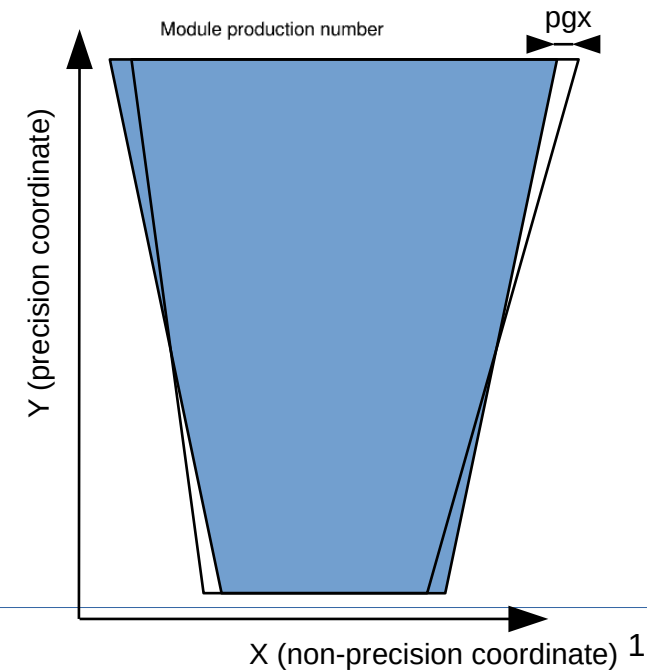
Plot above shown last week: elongations and deformations of top module layer seen by BB5 jig with respect to the measurements at construction sites.

My main concern: validity of elongation parameters

But for now: investigate the validity of parameter  $pgx$

Two checks:

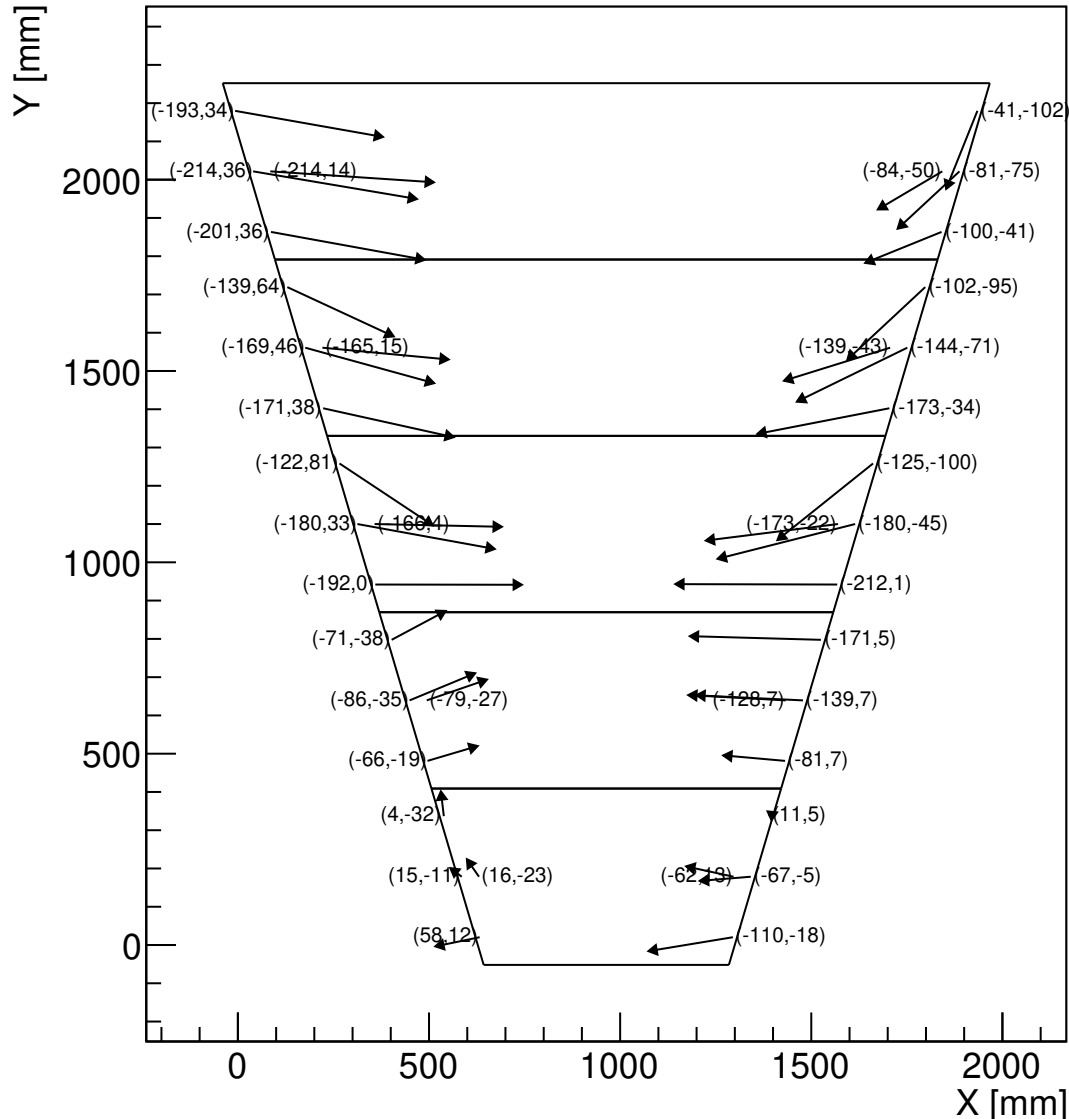
- 1) For LM1: measurement at construction site performed on assembled module, compare to BB5 jig value
- 2) Look for  $pgx$  using the rasfork data



**LM1: measurement of assembled modules**

# LM1: measurement of assembled modules

20MNMRL1E00019 side A



Starting point: gantry CMM measurement of panel layer measured just after panel gluing

Each arrow corresponds to one rasmask and shows the observed deviation to nominal

Frame (X,Y,THZ) is chosen such that

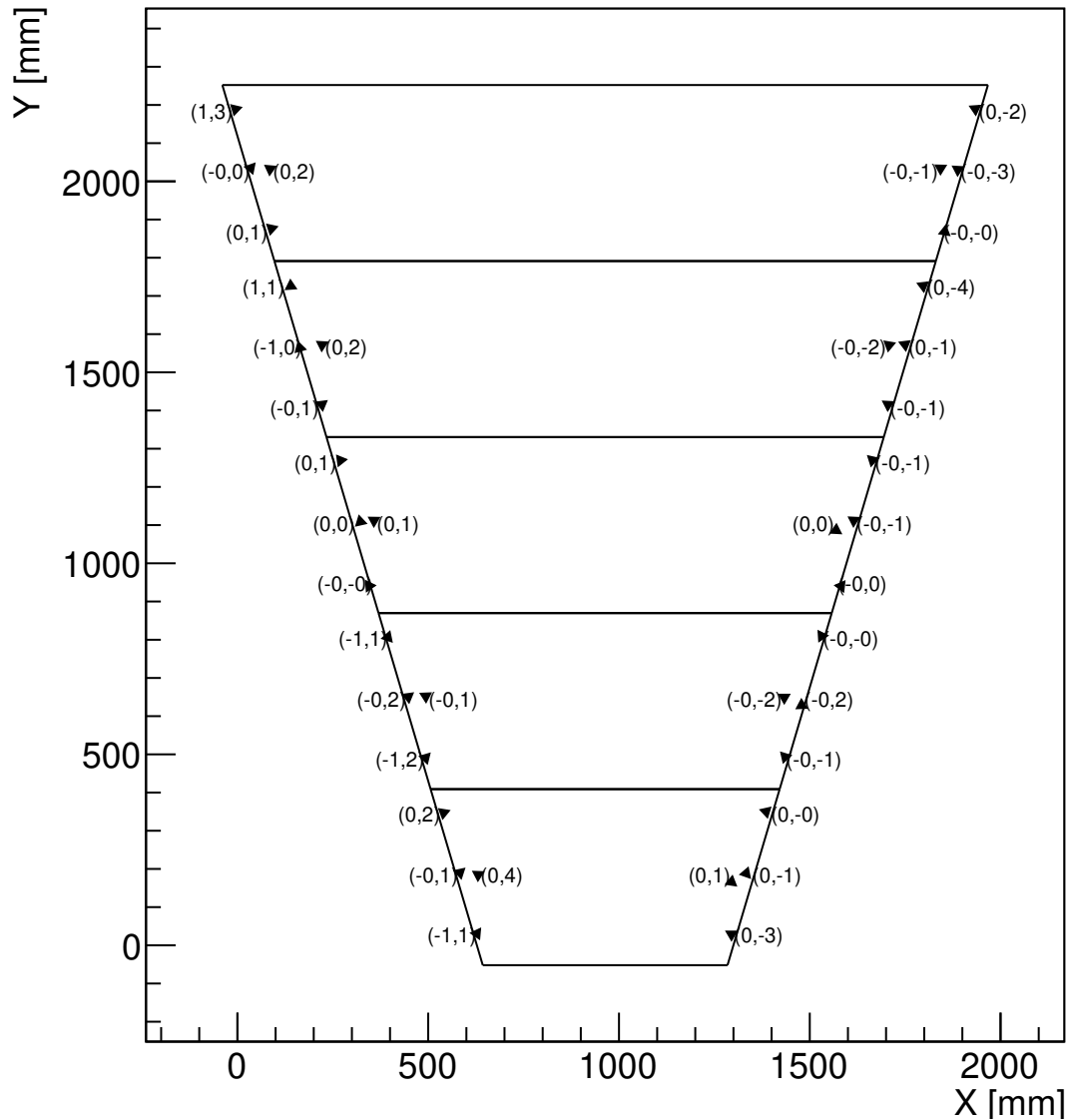
- Vertical measurements of bottom masks of PCB 3 are nominal (Fixes Y and THZ)
- Horizontal measurements of all masks are balanced (Fixes X)

What we see on this plot:

- Initial elongations and deformations of the PCBs
- Precision of positioning of the boards during panel assembly

# LM1: measurement of assembled modules

20MNMRL1E00019 side A

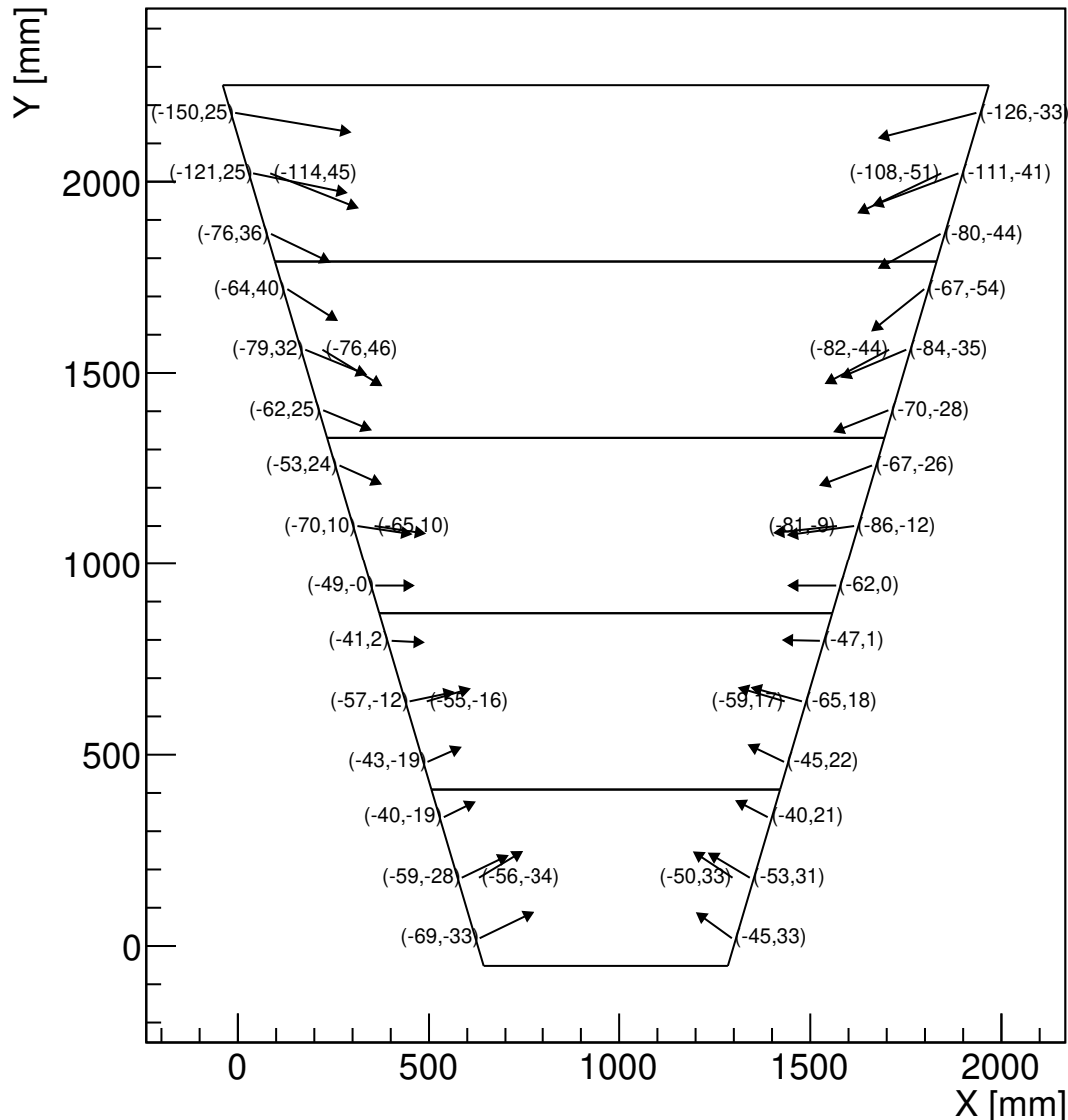


Step 1: offset each mask to its measured value  
This offset is always applied in the following

In other words: use the panel measured after  
gluing as a reference, and show relative  
displacements with respect to this reference in  
the following

# LM1: measurement of assembled modules

20MNMRL1E00019 side A



Gantry CMM measurement after panel drying and module assembly

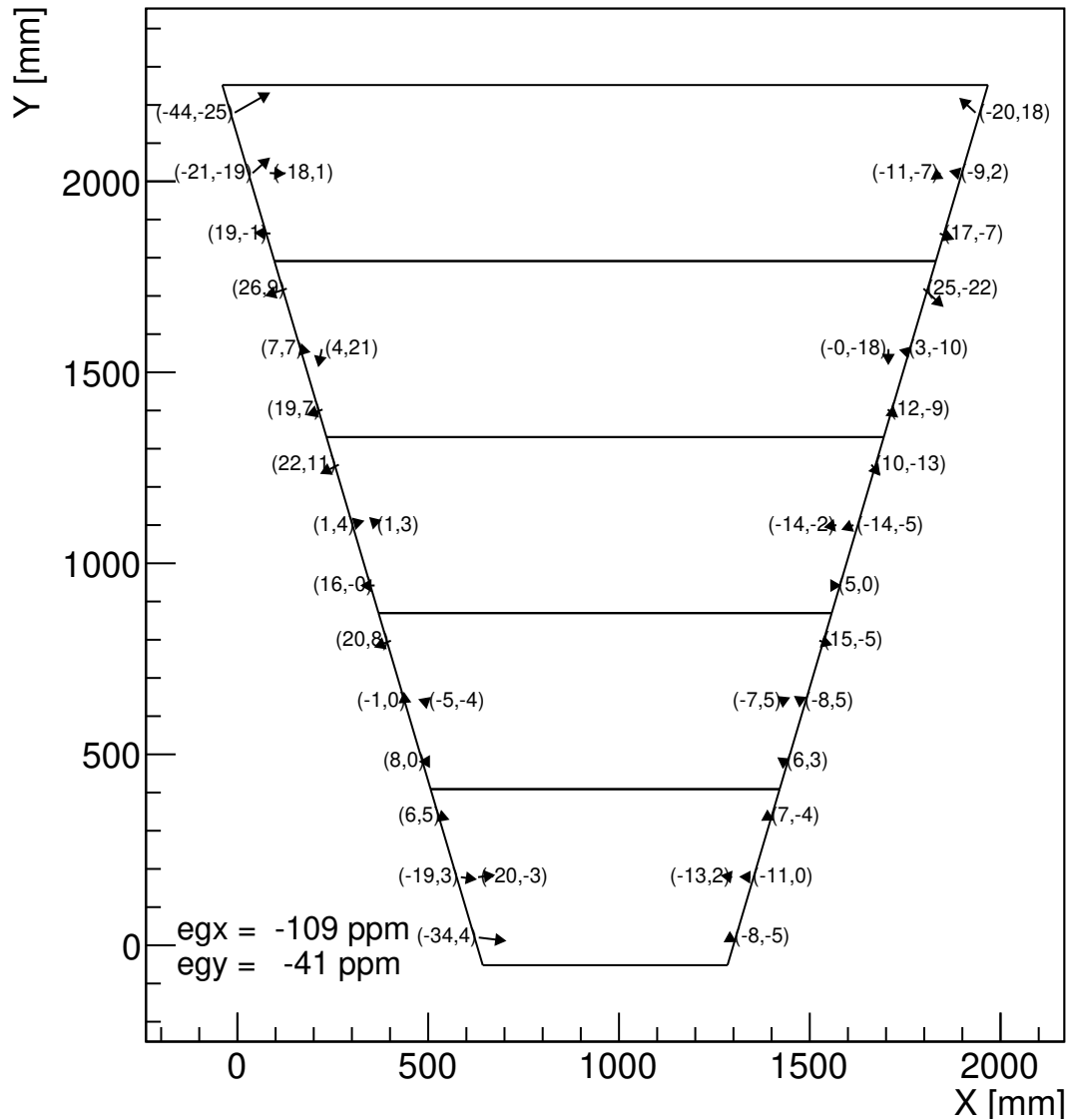
(Offset is applied to masks using the reference measurement at panel gluing)

What we see here:

- Overall elongation of the panel, consequence of the drying
- The center of the panel also deforms, but this is invisible here: cannot measure the strips on assembled module

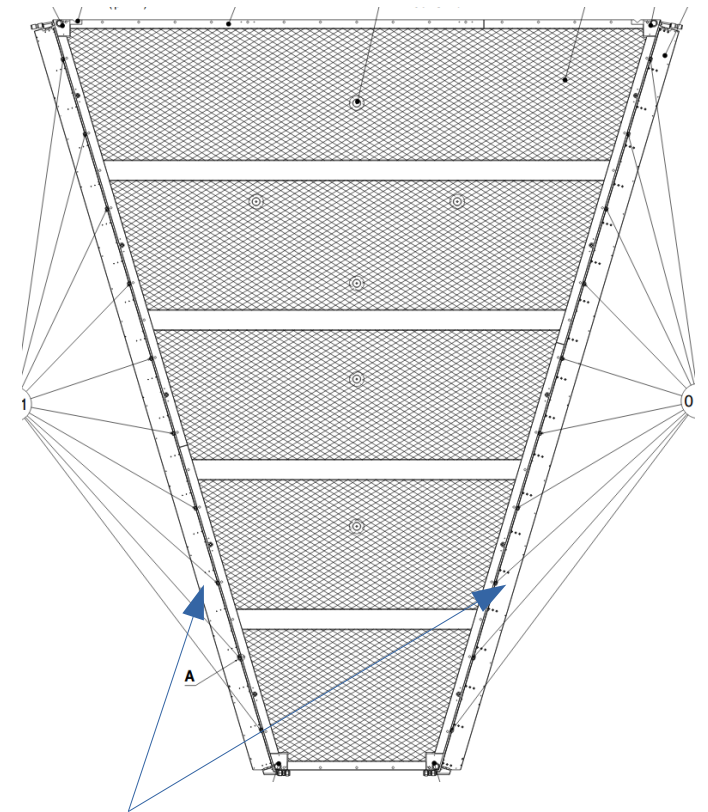
# LM1: measurement of assembled modules

20MNMRL1E00019 side A



Gantry CMM measurement after panel drying and module assembly: fit parameters egx and egy

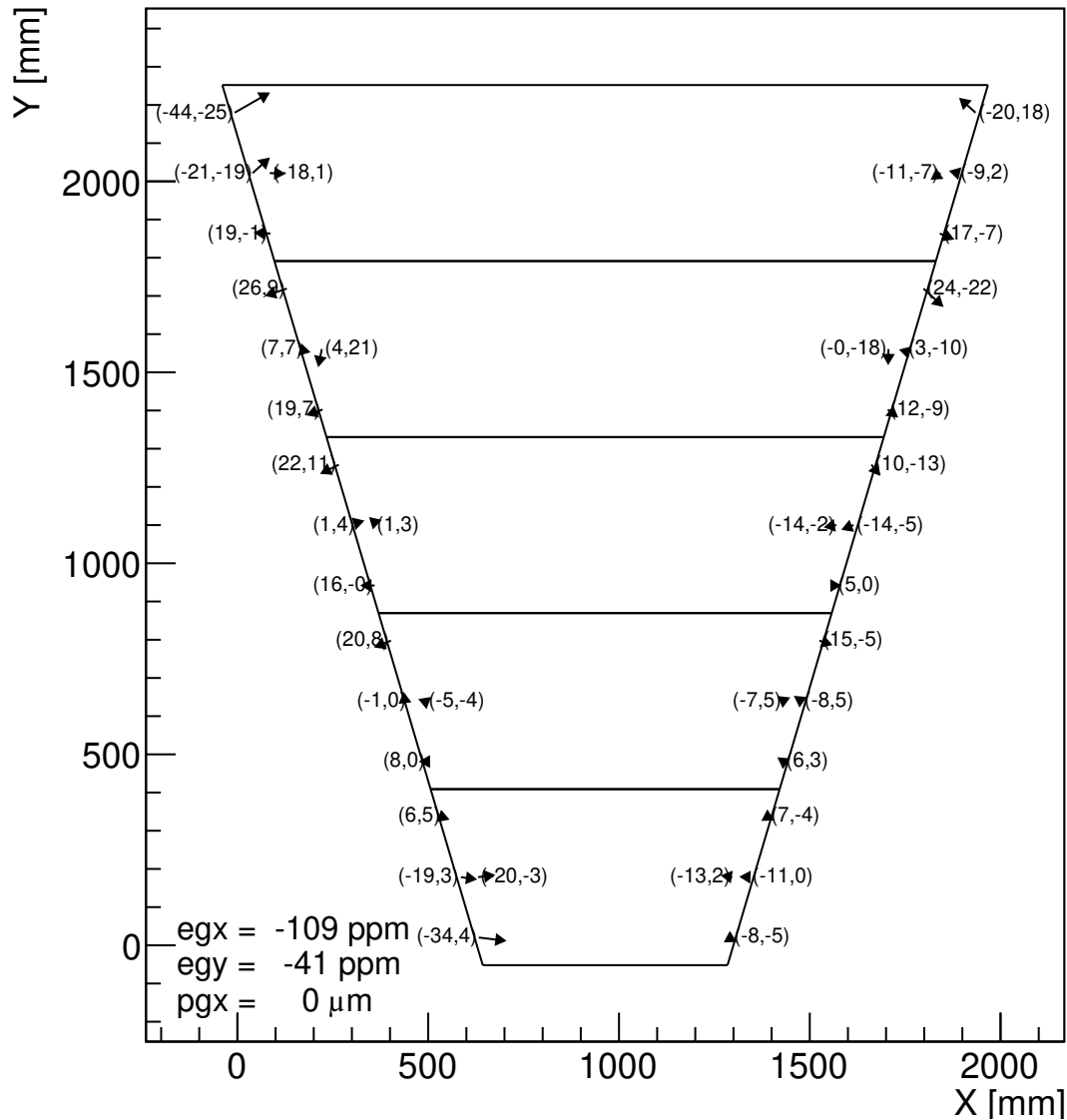
Note: egx shrinks more than egy because of internal structure of panel



Cooling bars: stiff

# LM1: measurement of assembled modules

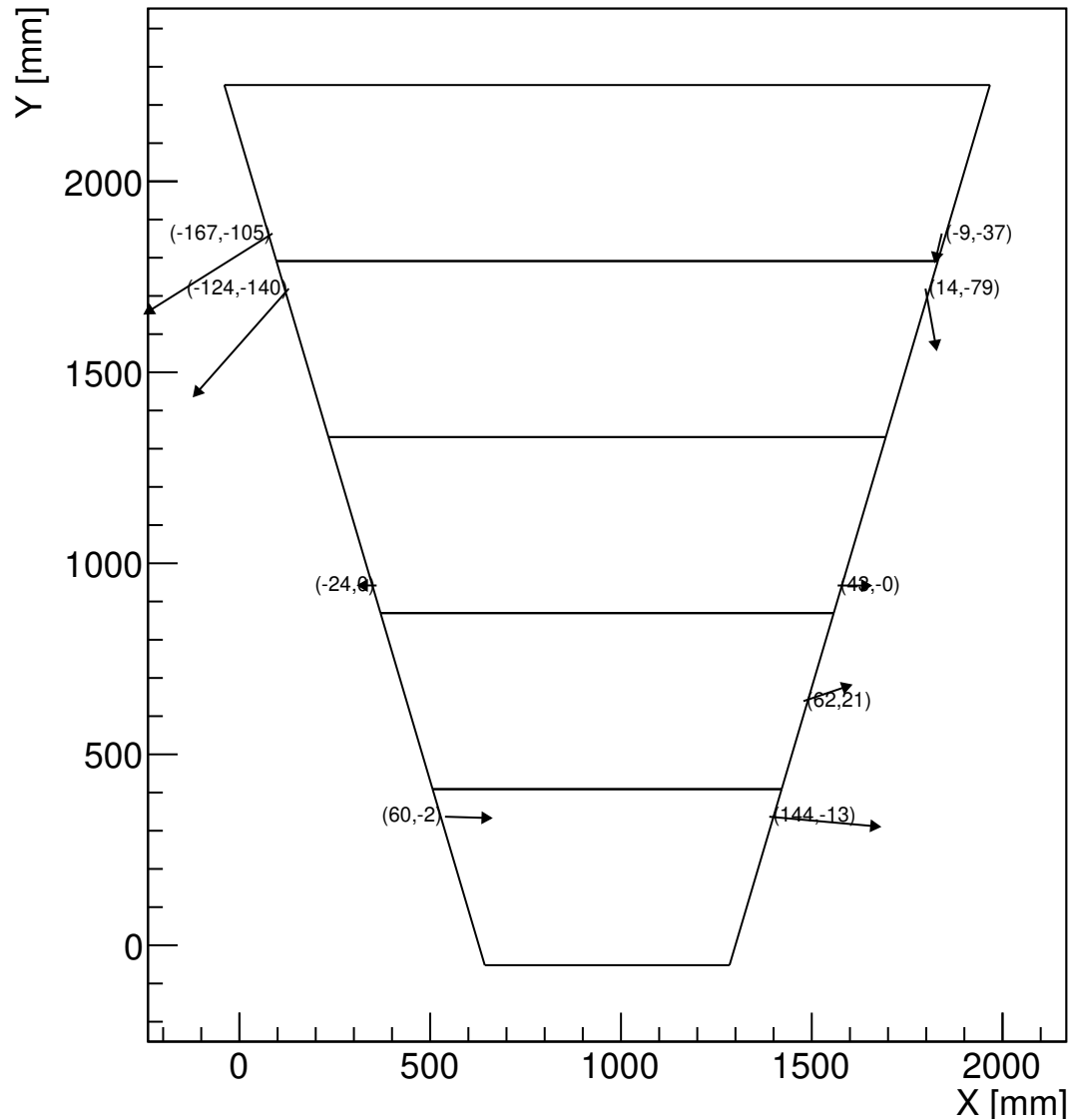
20MNMRL1E00019 side A



Gantry CMM measurement after panel drying and module assembly: fit parameters egx, egy and pgx (here: 0)

# LM1: measurement of assembled modules

20MNMRL1E00019 side A



BB5 jig measurement of the same panel layer

(Offset is applied to masks using the reference measurement at panel gluing)

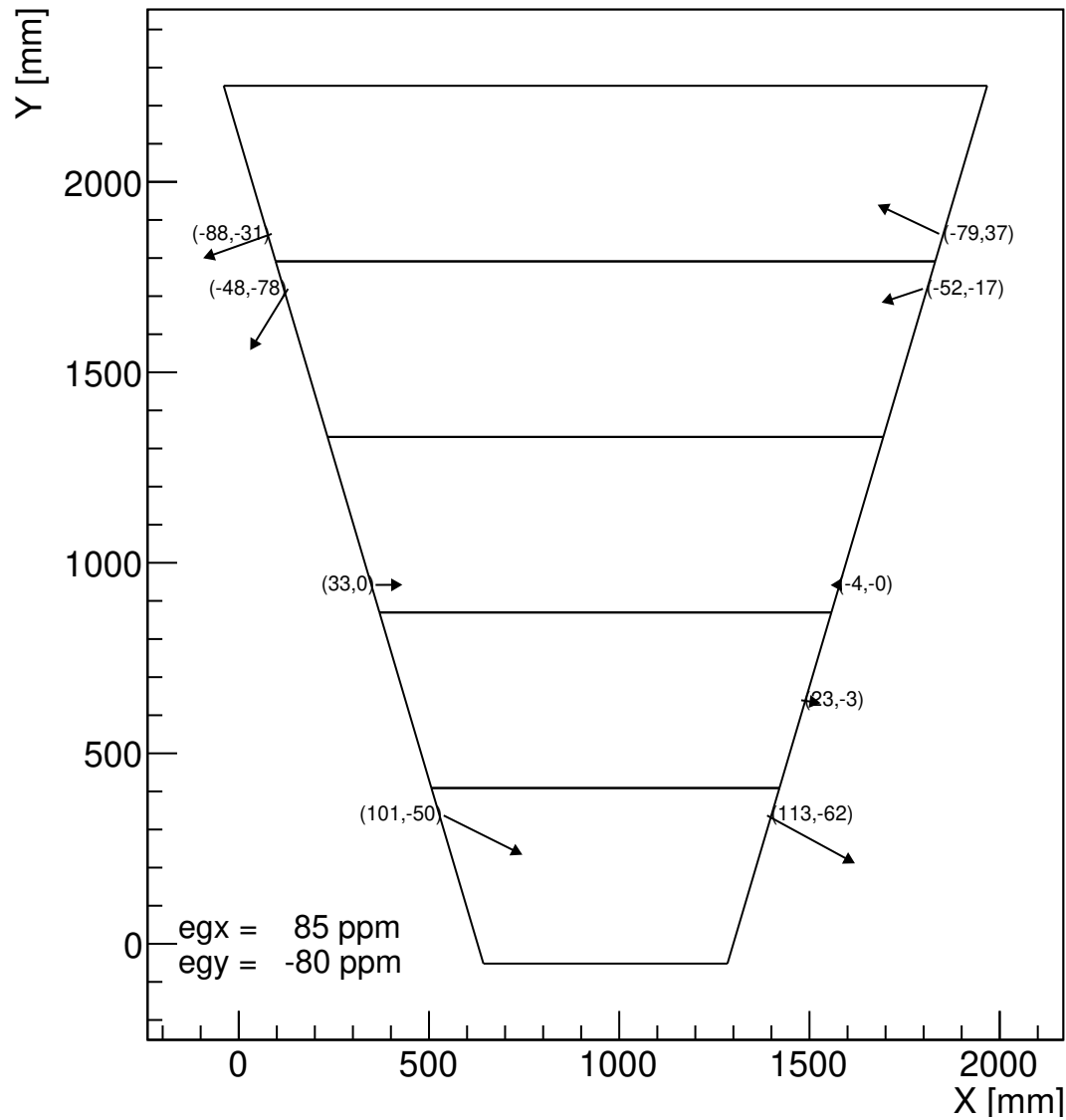
10 masks are measured for LM1.

Here: 1 faulty measurement on PCB 2



# LM1: measurement of assembled modules

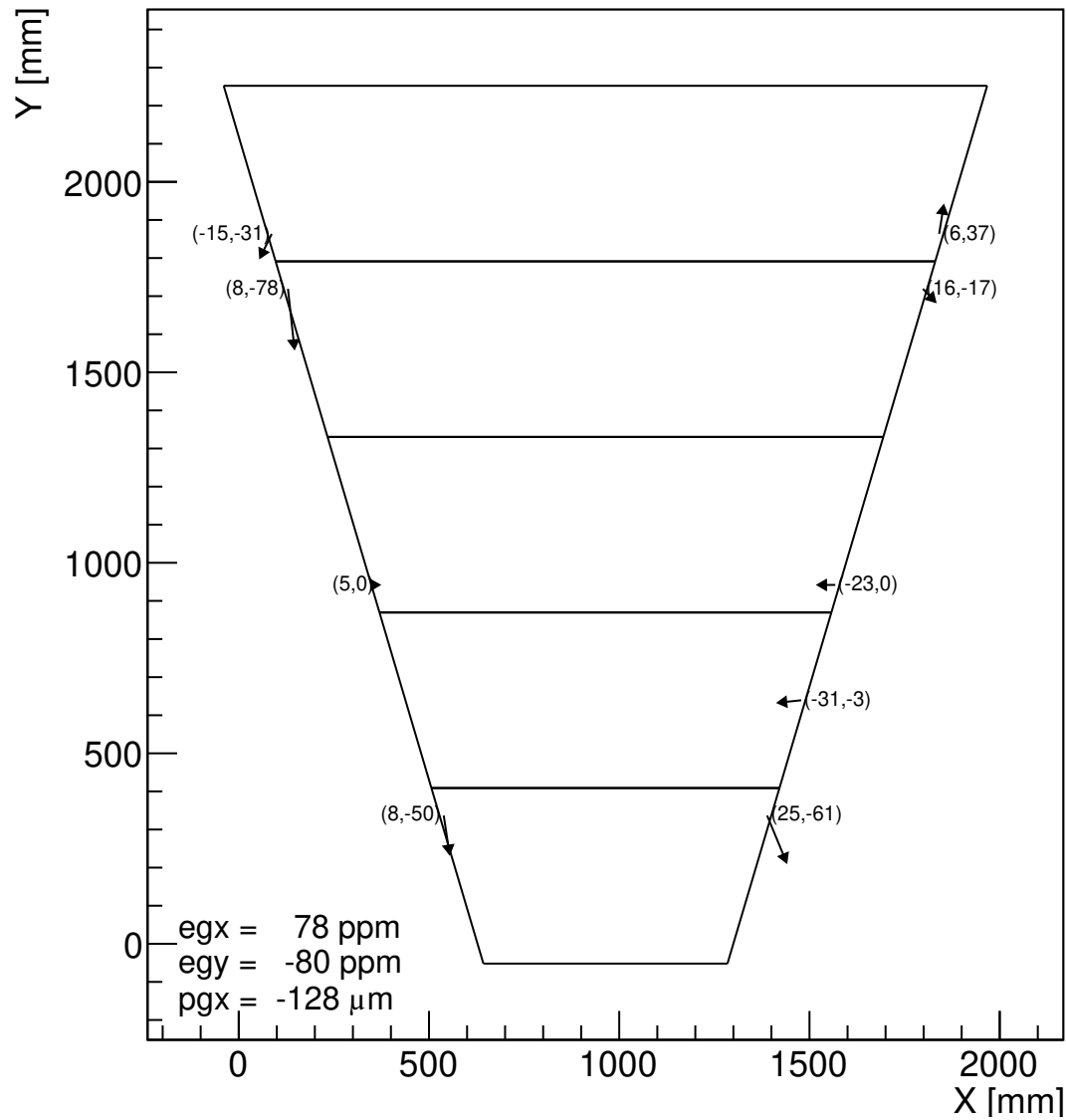
20MNMRL1E00019 side A



BB5 jig measurement: fit parameters egx and egy

# LM1: measurement of assembled modules

20MNMRL1E00019 side A



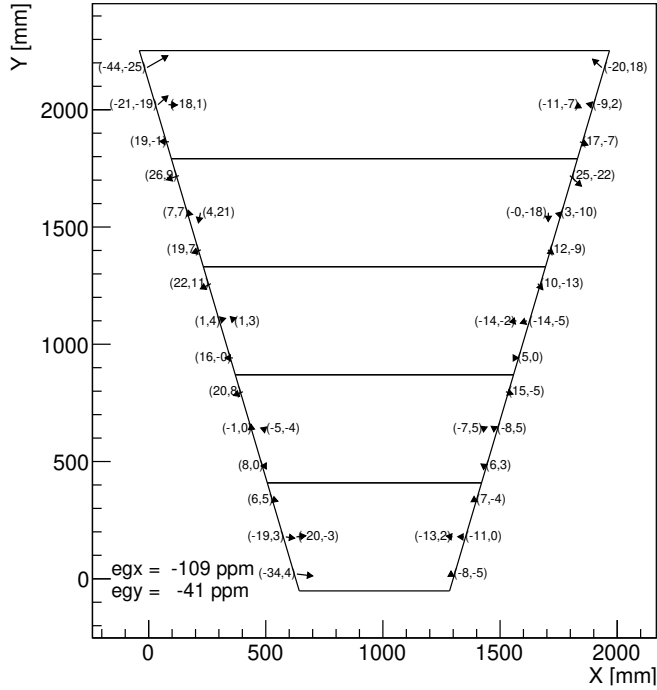
**egx and egy**

**egx, egy and pgx**

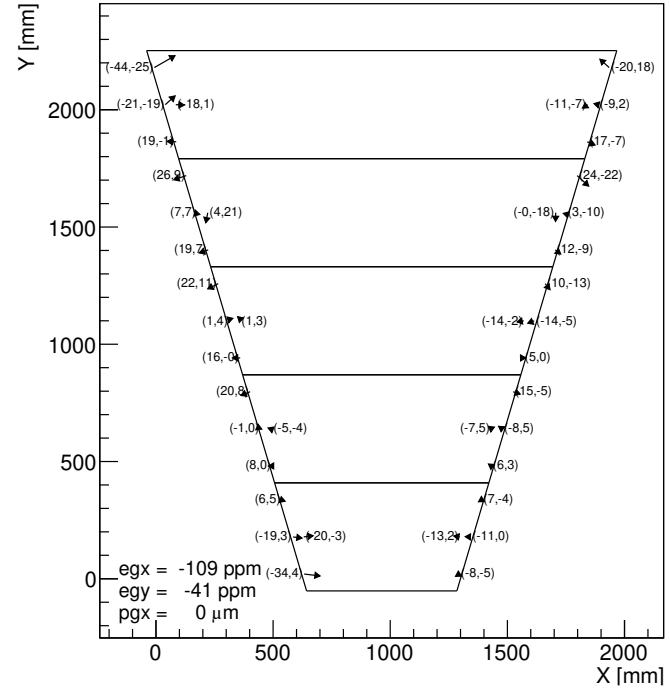
Saclay

BB5

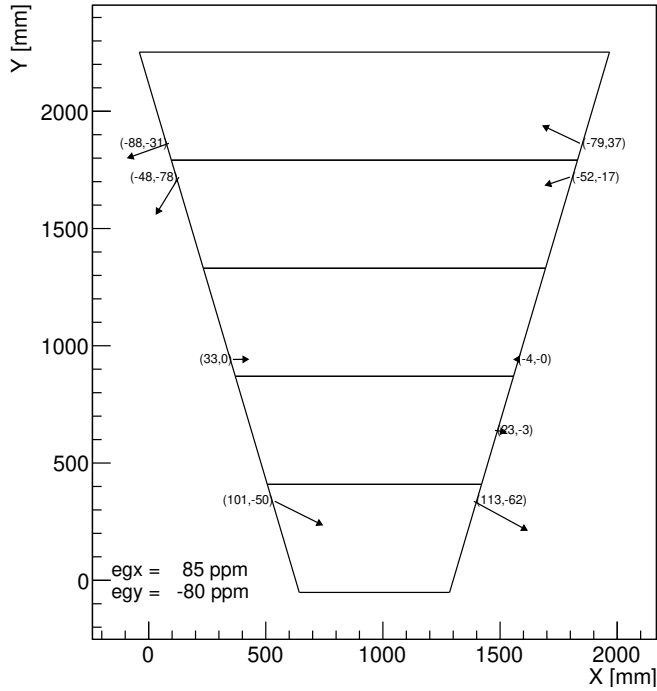
20MNMRL1E00019 side A



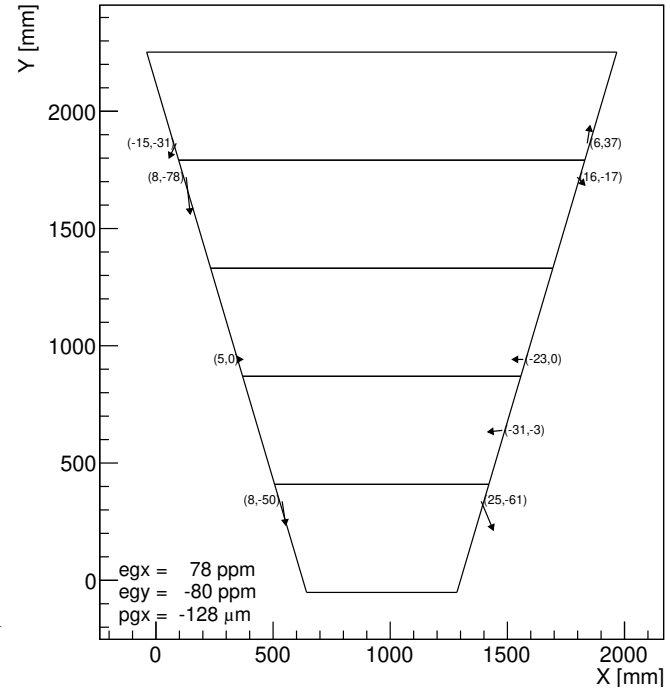
20MNMRL1E00019 side A



20MNMRL1E00019 side A



20MNMRL1E00019 side A



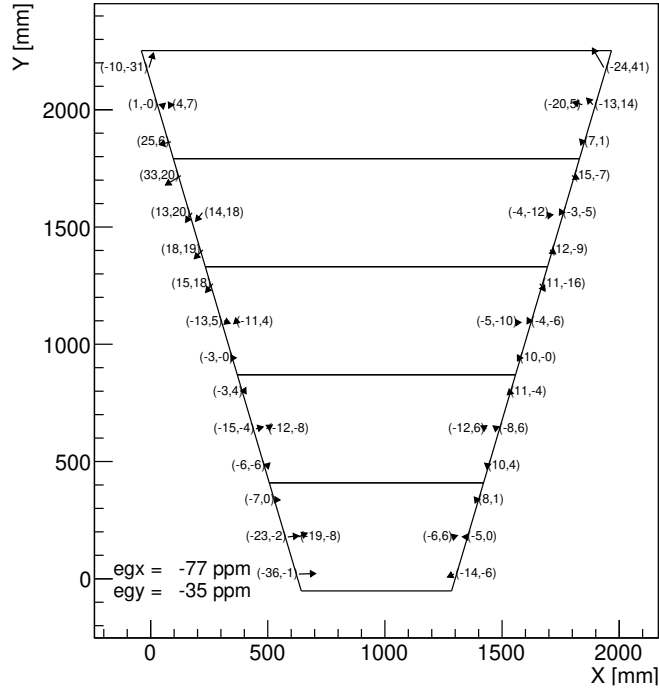
**egx and egy**

**egx, egy and pgx**

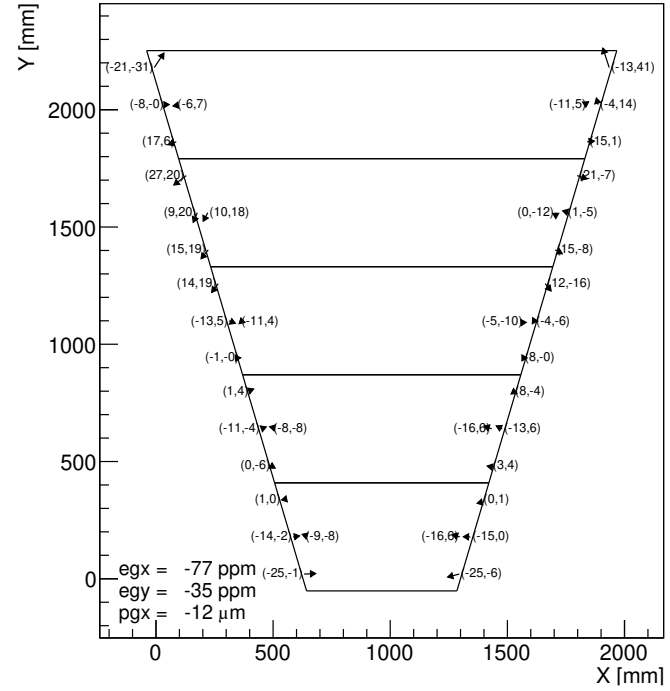
Saclay

BB5

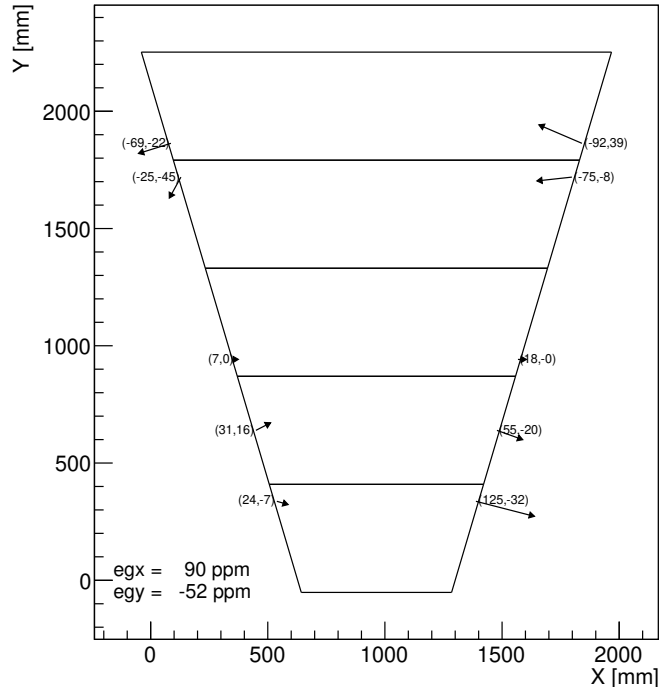
20MNMRL1E00015 side A



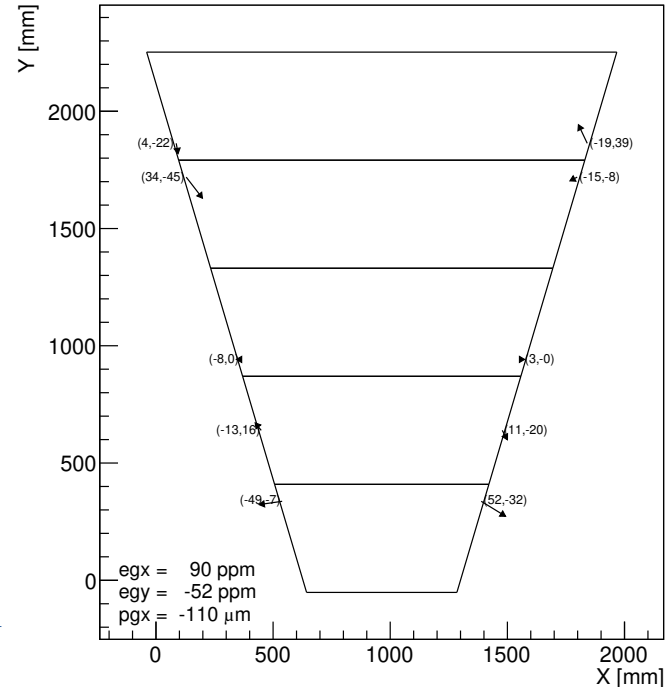
20MNMRL1E00015 side A



20MNMRL1E00015 side A



20MNMRL1E00015 side A



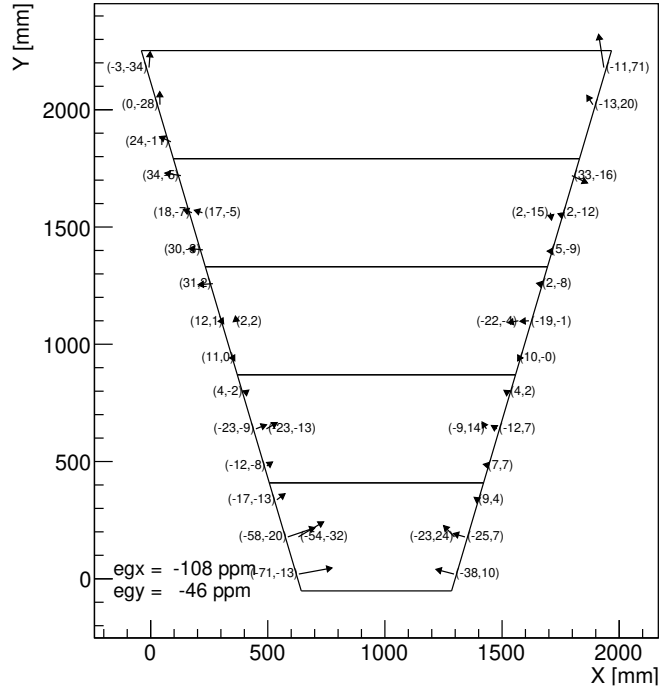
**egx and egy**

**egx, egy and pgx**

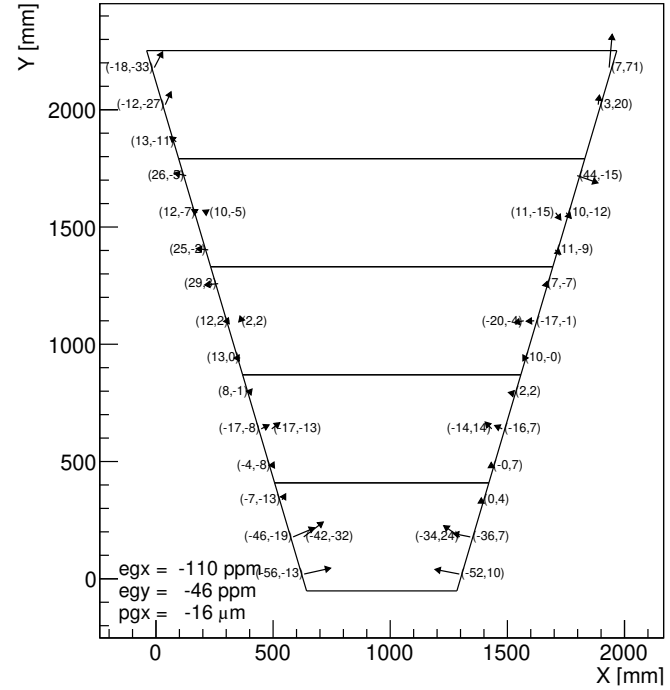
Saclay

BB5

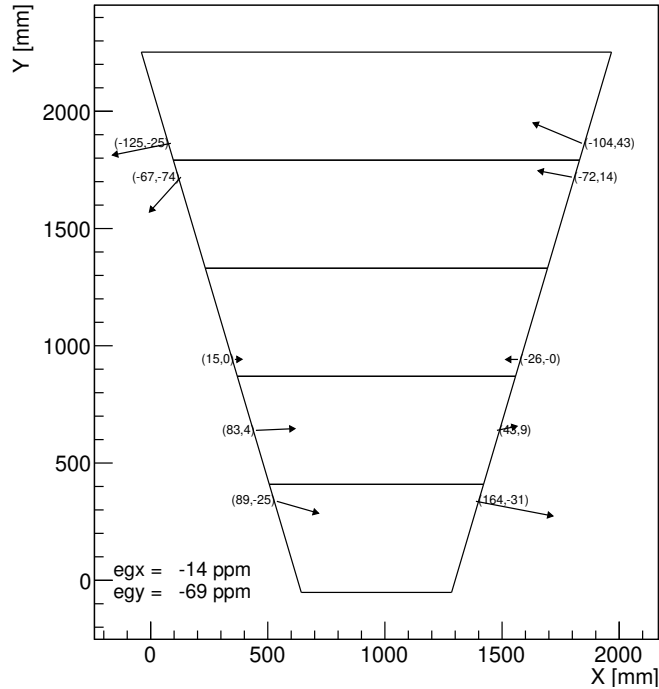
20MNMRL1E00027 side A



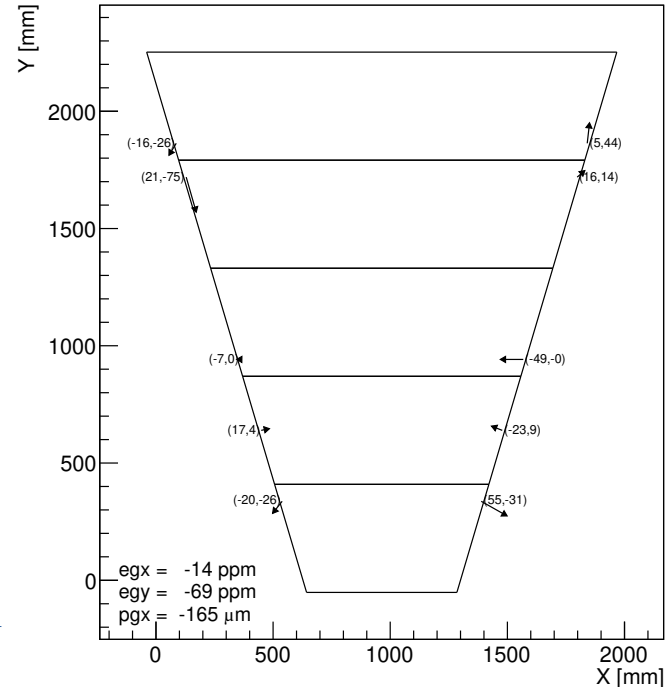
20MNMRL1E00027 side A



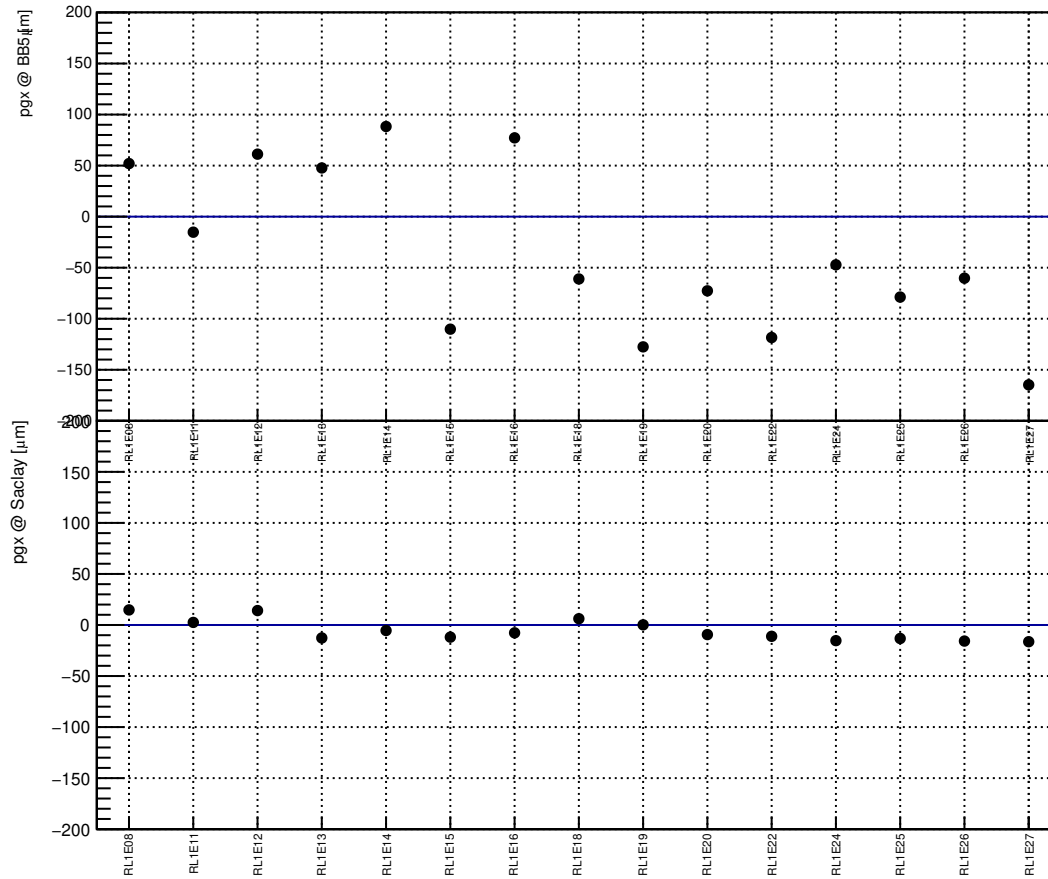
20MNMRL1E00027 side A



20MNMRL1E00027 side A



# Summary of LM1 measurements of assembled modules

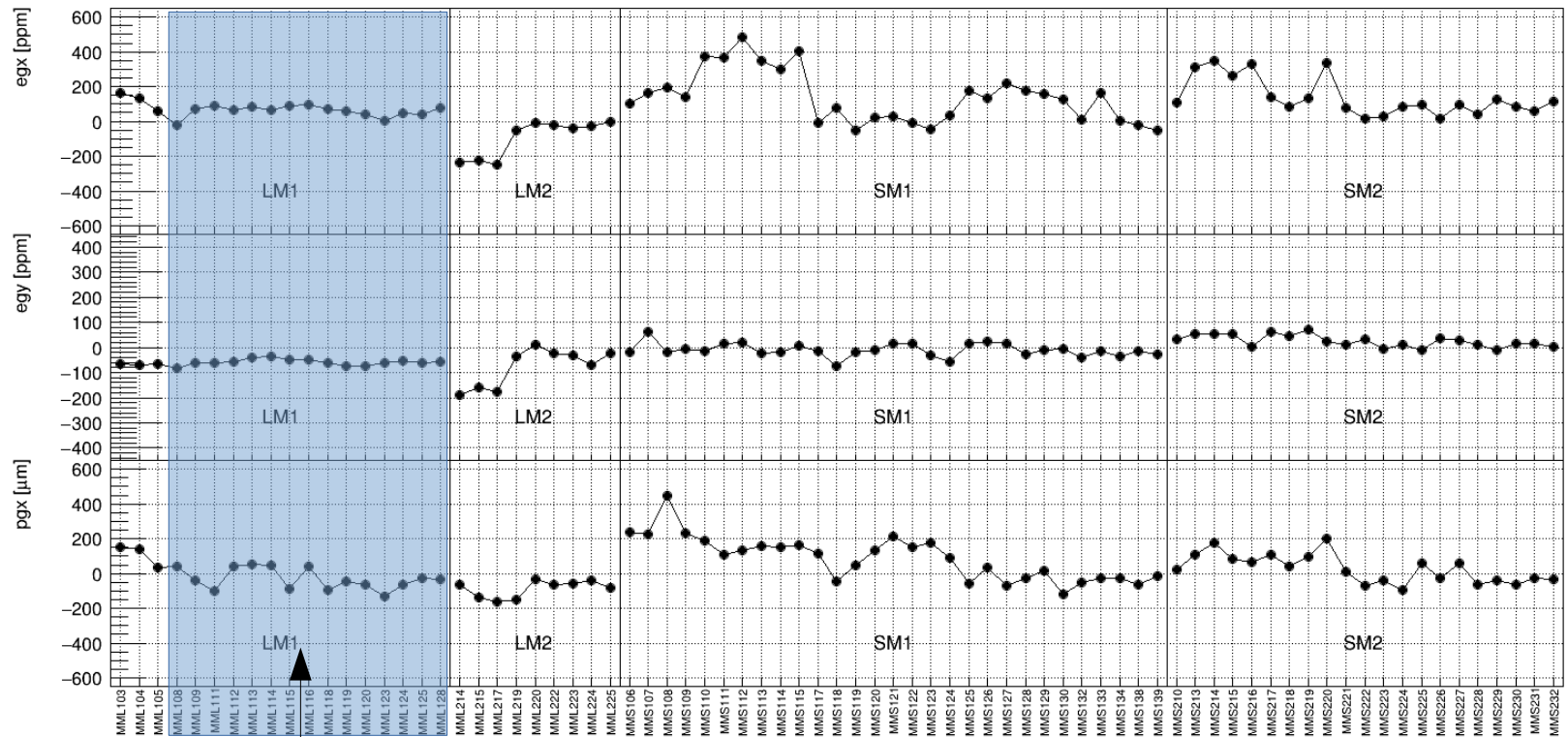


Larger pgx value is observed in the BB5 measurement

Probably at the limit of the precision of the BB5 jig

Look for pgx with help of rasfork data

# Investigating pgx



Subject of the previous slides

Module production number

What about the rest of the production?

Three possibilities:

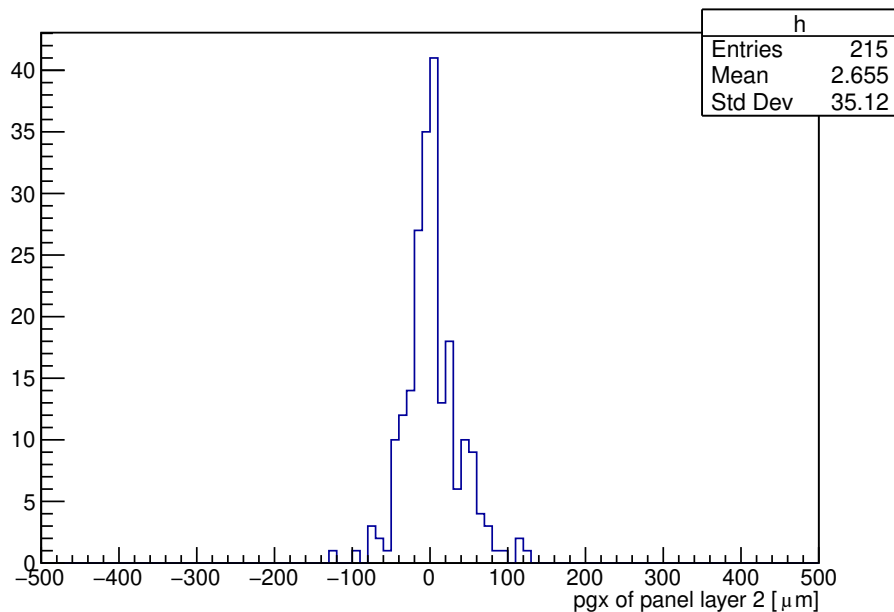
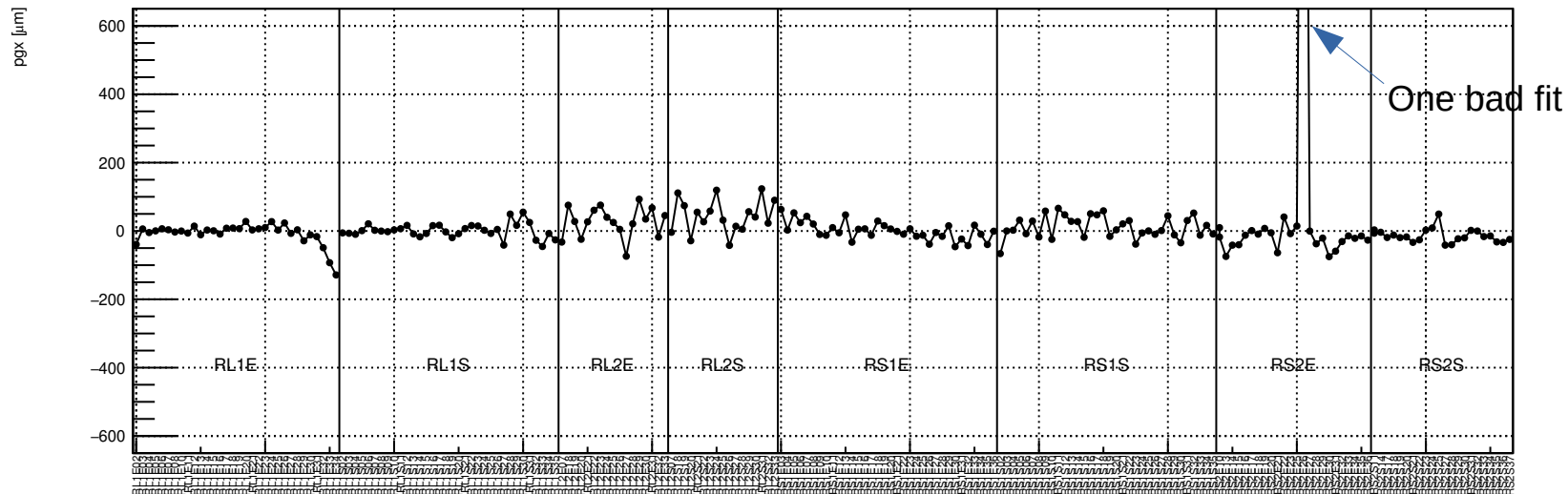
- 1) Observed pgx is real
- 2) BB5 measurement is biased or imprecise
- 3) Measurements at construction sites are biased or imprecise

Example gantry CMM measurement at construction site

- Possible systematic bias: angle between the X and Y axes
- Both panel sides are measured in CMM
- A pgx systematics would be visible when comparing with the rasfork measurements



# Fit pgx in panel measurements



Perform full metrology fit for panels:

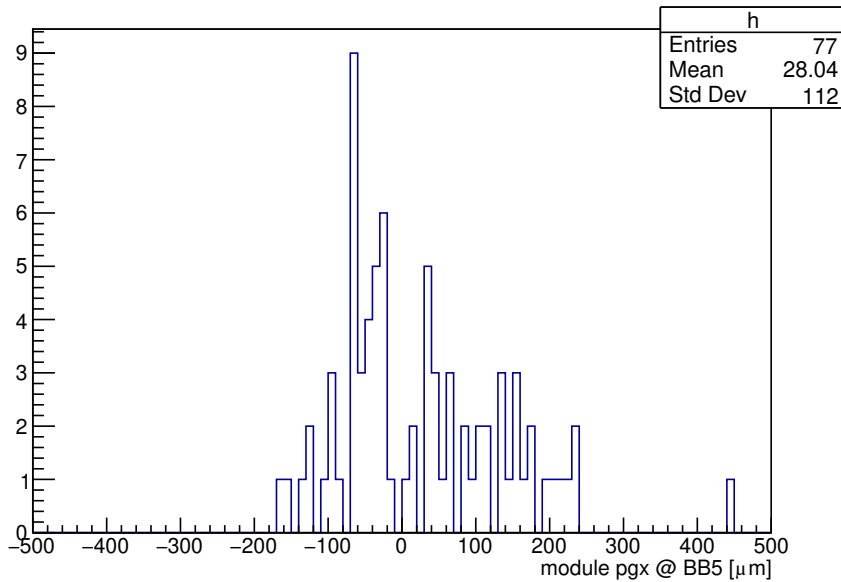
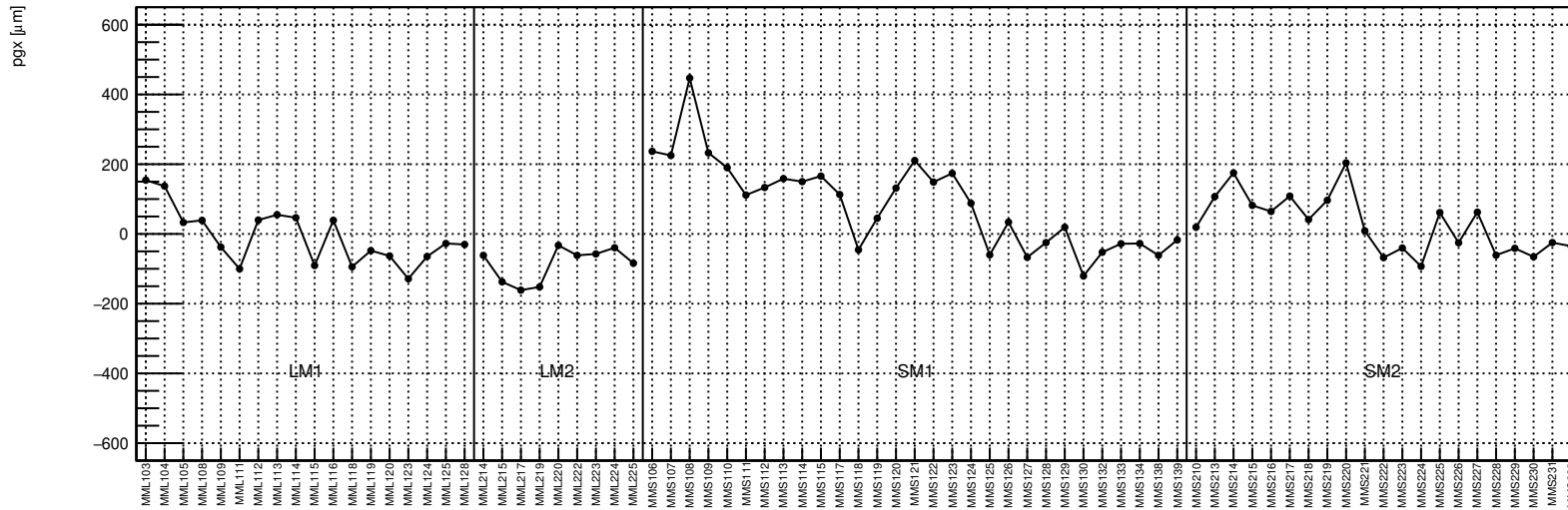
- Gantry CMM or contact-CCD table
- 2-rasfork
- CERN QAQC PCB measurements

With additional parameter: pgx for one of the two panel sides

If bad of gantry: expect to see on BB5 jig measurement

- Factor 2 smaller values if systematic constant angle bias of the layer measurement
- Factor  $\sqrt{2}$  smaller values if stochastic error (reproducibility)

# Reminder of the BB5 result



Conclusion can be one of two things:  
1) Effect is real  
2) Systematic bias in BB5 measurement